





# (0.635 mm) .025" PITCH • QMS/QFS SERIES

QMS **Board Mates:** 

**OFS** 

**OMS** 

**QFS Board Mates:** 

QMS/QFS

Cable Mates: 6QCD

Standoffs: SO, JSOM

#### **SPECIFICATIONS**

Insulator Material: Liquid Crystal Polymer Contact & Ground Plane Material: Phosphor Bronze Plating: Au over 50 μ" (1.27 μm) Ni (Tin on Ground Plane Tail) Current Rating: Contact: 2.6 A per pin (2 pins powered) Ground Plane: 15.7 A per ground plane (1 ground plane powered) Operating Temp Range: -55 °C to +125 °C Voltage Rating: 300 VAC

## **PROCESSING**

Lead-Free Solderable:

QMS SMT Lead Coplanarity: (0.10 mm) .004" max

(026-052)(0.15 mm) .006" max (078)\* \*(.004" stencil solution may be available; contact ipg@samtec.com)

QFS SMT Lead Coplanarity:

(0.10 mm) .004" max (0.26 - 0.78)

Board Stacking:

For applications requiring more than two connectors contact ipg@samtec.com

## **STANDARDS**

SUMIT™ PCI/104-Express™ OneBank

Visit samtec.com/standards for more information, including mated heights and complete part numbers.

QMS

QMS LEAD STYLE

-05.75

-06.75

-09.75

(8.13)

PINS PER ROW NO. OF PAIRS

-026,

-052, -078

(52 total pins per bank = -D)

-016,

-032, -048 (16 pairs per bank = -D-DP)

(-078 & -048 Not available with -09.75

Lead Style)

**MATED HEIGHT\*** 

(5.38) .212

(6.35) .250

(9.35) .368

\*Processing conditions will affect mated height See SO Series for board space tolerances.

**QFS LEAD STYLE** 

-6.25

12 mm

13 mm

16 mm

-4.25

10 mm

11 mm

14 mm

STYLE

Specify

LEAD

STYLE

from

Chart

**PLATING** OPTION

**TYPE** -D

= Single-Ended

-D-DP

**-K** = (5.50 mm) .217" DIA Polyimide film Pick & Place

**PACKAGING** 

**OPTION** 

**OTHER** 

OPTION

Pad

= 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail (–05.75 & –06.75 Lead Style Only)

= Differential Pair

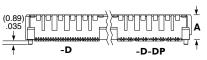
**-SL** = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail (-09.75 Lead Style Only)

(1.60 mm) .063" Nominal Wipe

Tape & Reel Options (-TR & -FR) available. Visit series web

page and view engineering prints for complete specifications.

(No. of Banks) x (21.34) .840 - (0.51) .020 7.26) .286





View complete specifications at: samtec.com?QMS

#### PINS PER ROW QFS NO. OF PAIRS

LEAD STYLE

Specify

LEAD

**STYLE** 

from

Chart

PLATING OPTION

= 10 μ" (0.25 μm)

Gold on contact,

Matte Tin on tail (–04.25 Lead Style only)

-SL

= 10 µ" (0.25 µm)

Gold on contact,

Matte Tin on tail

(-06.25 Lead Style only)

**TYPE** 

**OPTION** 

-D-DP = Differential Pair (–04.25 Lead Style only)

-D

= Single-

Ended

-GP = Guide Holes (-04.25 Lead Style only)

-016, -032, -048

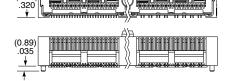
-026, -052,

-078

(52 total pins per bank = -D)

(16 pairs per bank = -D-DP)

GP = No. of Banks x (21.34) .840 + (12.45) .490 - No. of Banks x (21.34) .840 + (1.02) .040 →



LEAD STYLE	A
-04.25	(7.44) .293
-06.25	(9.42) .371

# **PACKAGING OPTION**

Tape & Reel Options (-TR & -FR) available. Visit series web page and view engineering prints for complete specifications.

#### Note:

Some lengths, styles and options are non-standard. non-returnable.

View complete specifications at: samtec.com?QFS